



TARGET THICKNESS: 0.062"
NUMBER OF LAYERS: 04

MULTILAYER PCB CONSTRUCTION SHEET

If there are max thickness requirements beyond +/- .10% overall - non-standard construction should be ordered and notes added.

4 Layer StackUp (0.062") L04-062-2oz2oz			Thickness (inches)
Layer 1	2 oz foil plated to approximate* thickness 0.0038"		0.0038
Prepreg	Bonding ply (3x 1080, 2x7628) Average Dielectric Constant 4.5		0.0141
Layer 2	2 oz foil thickness		0.0028
Core	Laminate Core Average Dielectric Constant 4.5		0.021
Layer 3	2 oz foil thickness		0.0028
Prepreg	Bonding ply (3x 1080, 2x7628) Average Dielectric Constant 4.5		0.0141
Layer 4	2 oz foil plated to approximate* thickness 0.0038"		0.0038
"Thickness does not include soldermask or surface finish"			0.0624

NOTES: